# ISA-WELD SHUNT CHIP RESISTORS

BVR, BVB

#### **Features**

- Shunt chip resistor with 4 terminals developed for current detection in automotive motor drivers, inverters, wattmeters, etc.
- Excellent electrical and mechanical structure realized by the electron beam welding.

BVR Max. Current (Continuous)  $160A / 0.2m\Omega$  BVB Max. Current (Continuous)  $160A / 0.2m\Omega$ 

Туре	Load Capacity (W) *	Resistance (Ω)	Tolerance (%)	Temp. Coefficient (20°C ~60°C)	Internal Heat Resistance (°C/W)a-b	Thickness t (mm)
BVR-Z-R0002	5	0.2m			4	1.20
BVR-Z-R0003	5	0.3m			5	0.85
BVR-Z-R0005	5	0.5m			8	0.42
BVR-M-R0007	4	0.7m	±1, ±5	±50ppm/℃	12	0.44
BVR-M-R001	4	1m			14	0.35
BVR-I-R002	4	2m			14	0.55
BVR-1-B003	3	3m	1		21	0.36

<u>▲ Precautions</u> Refer to the power derating curve. Proper measures for heat radiation should be taken.

BVR BVB

Resistance Material Z : Zeranin M : ISA Manganin

I: ISA-Ohm

Specification
Operating Temp.:-55°C ~+170°C
Free Air Load Capacity: 0.5W
Solder Reflow: Max.255°C (t < 40sec)

Resistance Material	Z : Zeranin
	M : ISA Manganin
	I: ISA-Ohm

Specification

Weight: 0.3g

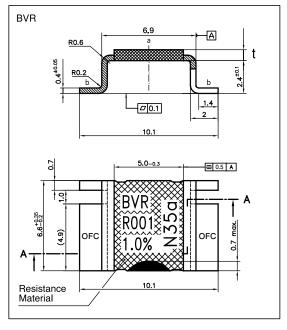
Operating Temp. : -55 $^{\circ}$ C  $\sim$ +170 $^{\circ}$ C Free Air Load Capacity : 0.5W Solder Reflow : Max.255 $^{\circ}$ C (t < 40sec)

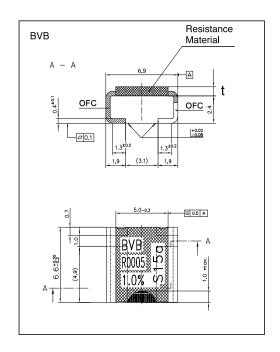
Weight: 0.35g

Type	Load Capacity (W) *	Resistance $(\Omega)$	Tolerance (%)	Temp. Coefficient (20°C ~60°C)	Internal Heat Resistance (°C/W)a-b	Thickness t (mm)
BVB-Z-R0002	5	0.2m	±1. ±5 ±50ppm/°C		4	1.20
BVB-Z-R0005	5	0.5m			8	0.45
BVB-M-R001	5	1m		±50ppm/°C	15	0.35
BVB-I-R002	4	2m			14	0.55
BVB-I-R003	3	3m			21	0.36
BVB- I- R005	2	5m			33	0.36

<u>▲ Precautions</u> Refer to the power derating curve. Proper measures for heat radiation should be taken.

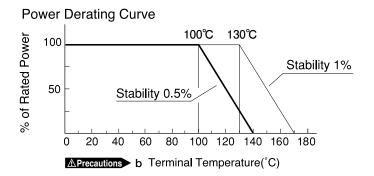
#### **Shape & Dimensions**



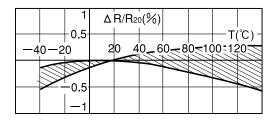


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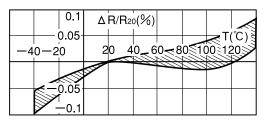
BVR, BVB



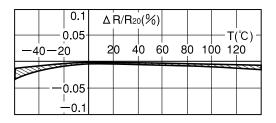
## Resistance Change Versus Temp. (ISA-Manganin)



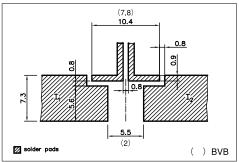
### Resistance Change Versus Temp. (Zeranin)



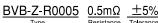
## Resistance Change Versus Temp. (ISA-Ohm)



# Recommended PCB layout: BVR, BVB



How to order



Taping Specification

BVR: DIN EN 60286-3 Tape width 24mm 1400pcs BVB: DIN EN 60286-3 Tape width 16mm 1400pcs

- Order for a single piece of standard in-stock items accepted
- AEC-Q200 Qualified

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BVR-Z-R0002 0.2mΩ±1%	
BVR-Z-R0003 0.3mΩ±1%	
BVR-Z-R0005 $0.5$ m $\Omega \pm 1\%$	
BVR-M-R0007 $0.7$ m $\Omega \pm 1\%$	
BVR-M-R001 $1 \text{m}\Omega \pm 1\%$	
BVR-I-R002 $2m\Omega \pm 1\%$	

#### Performance

Parameters	Test Conditions	Specification
Thermal Shock	-65°C, 25°C, 125°C, 25°C 25cycles	±0.1%
Over load	5×Wattage Rating 5sec	±0.2%
Resistance to Solvents	IPA 3min	No damage
Low Temp. Storage and Operation	MIL-R-26E	±0.1%
Resistance to Soldering Heat	260°C 10sec	±0.2%
Moisture Resistance	Near 100%RH, +25°C, +65°C, -10°C 10cycles (10days)	±0.2%
Shock	50g's, 11ms	±0.2%
Vibration, High Frequency	MIL-STD-202 Method 204D-B	±0.2%
Load Life ※1	1.5Hr ON 0.5Hr OFF 2000Hr	±0.5%
Load Life ※2	1.5Hr ON 0.5Hr OFF 2000Hr	±1%
Storage Life at Elevated Temp.	MIL-STD-202 method 108A-F	±0.3%
High Temperature Exposure	140°C, 2000Hr	±0.5%
Current Noise	MIL-STD-202 method 308	±0.01%
Voltage Coefficient	MIL-STD-202 method 309	linearity error less than 120dB
Thermal EMF(µV/°C)	0~100°C	2μV/°C max
Frequency Characteristic	Inductance (1mΩ)	<3nH

\*1 Treminal Temp. BVB: Max.150°C BVR: Max.100°C